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## 12-14-1998



U.S. DEPARTMENT OF COMMERCE

1- Ma.		Patent and Trademark Office
	100	921210 ————
Τq		ラと I と I O e attached original documents or copy thereof.
1.	Name of conveying party(ies):	2. Name and address of receiving party(ies):
	Ken Higuchi, Hiroshi Katsuno, Masahide Fujita	Name: Sony Corporation
Additional name(s) of conveying party(ies) attached?		Street Address: 7-35 Kitashinagawa, 6-chome, Shinagawa-ku, City, State and Zip: Tokyo, Japan
	☐ Yes     No	
3. ⊠	Nature of Conveyance:	
_		Additional Name(s) & address(es) attached?
Ц	Security Agreement Change of Name Other	□ <sub>Yes</sub> ⊠ <sub>No</sub>
	Execution Date: October 29, 1998 and October 30, 1998	
4.	Application number(s) or patent number(s): 09/156,035	
If this document is being filed together with a new application, t		ion, the execution date of the application is:  B. Patent No.(s)
	A. Patent Application No.(s)	o. retent no.(s)
	Additional numbers attached?	I ⊠ <sub>No</sub>
5.	Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved: 1
	Name: Philip M. Shaw, Jr.	7. Total fee (37 CFR 3.41):\$ 40.00
	Internal Address: Crosby, Heafey, Roach & May	☑ Enclosed
	Street Address: P.O. Box 7936 City, State, ZIP: San Francisco, California 94120-7936 Telephone: (415) 659-5904 Facsimile: (415) 391-8269	Charge any deficiencies in the enclosed fee to Deposit Account No. 03-3821, designating our file: 21778.01000
	Attorney Docket No. 21778.01000	Authorized to be charged to deposit account
11/3	0/1998 GDUCKETT 00000019 09156035	8. Deposit account number: 03-3821
02 F	C:581 40.00 OP	Deposit account number: 03-3621
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9.	Statement and signature.	
	To the best of my knowledge and belief, the foregoing information is true and corre	ect and any attached copy is a true copy of the original document.
	$\mathcal{M}$	to and or
	Philip M. Shaw, Jr.  Name of Person Signing	1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1
	Total number of p	mages including cover sheet, attachments and document: 3
	Do not detach	this portion
	Mail documents to be recorded with required cover sheet information to:	
	Commissioner of Patents and Trademarks, E	Box Assignments, Washington, D.C. 20231
	Public burden reporting for this sample cover sheet is estimated to average about 30 m and gathering the data needed, and completing and reviewing the sample cover sheet. Office, Office of Information Systems, PK2-1000C, Washington, D.C. 20213, and t 0011), Washington, D.C. 20503	Send comments regarding this burden estimate to the LLS. Patent and Trademork

PATENT<sub>Revised: 04/21/97</sub> REEL: 9630 FRAME: 0580

Docket Ni

Docket Number: 21778.01000

## ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in SHEET PACKAGE AND PRINTER IN WHICH SHEETS ARE SET BY THE SHEET

PACKAGE

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address:

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 09/156,035, Filing Date: September 17, 1998

This assignment executed on the dates indicated below.

KEN HIGUCHI	
Name of first or sole inventor	Execution date of U.S. Patent Application
Kanagawa, Japan	
Residence of first or sole inventor	
Men Juguchi Signature of first or sole inventor	October 29 1998
Signature of first or sole inventor	Date of this assignment

PATENT REEL: 9630 FRAME: 0581

HIROSHI KATSUNO	
Name of second inventor	Execution date of U.S. Patent Application
Kanagawa, Japan	
Residence of second inventor	
Hiroshi Kateuno	October 29, 1998
Signature of second inventor	Date of this assignment
MASAHIDE FUJITA Name of third inventor	Execution date of U.S. Patent Application
Kanagawa, Japan	
Residence of third inventor	
masahide Fajita	October 30 1998
Signature of third inventor	October 30. 191) Date of this assignment
Name of fourth inventor	Execution date of U.S. Patent Application
Residence of fourth inventor	
Signature of fourth inventor	Date of this assignment
Name of fifth inventor	Execution date of U.S. Patent Application
Residence of fifth inventor	

PATENT REEL: 9630 FRAME: 0582

Date of this assignment

**RECORDED: 11/23/1998** 

Signature of fifth inventor